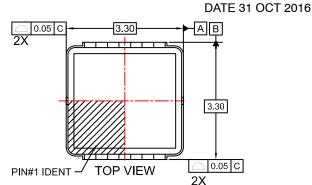
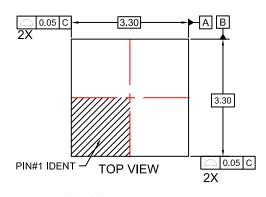
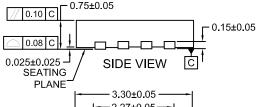


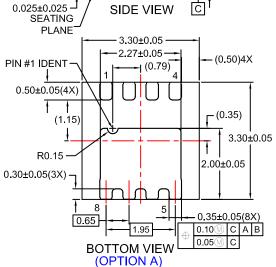
## WDFN8 3.3x3.3, 0.65P

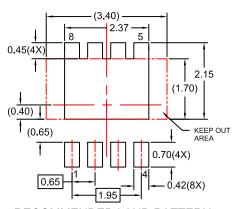
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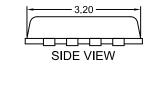


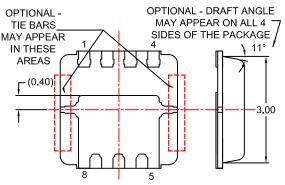












ALL DIMENSIONS AS PER OPTION A UNLESS SPECIFIED BOTTOM VIEW (OPTION B)

	ENDED LAND	
RECOMM	-	

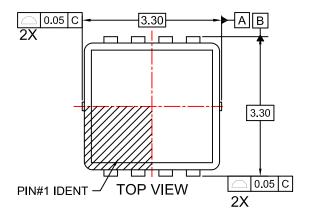
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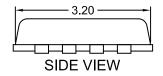
DESCRIPTION: WDFN8 3.3XX.3, 0.65P PAGE 1 OF 2

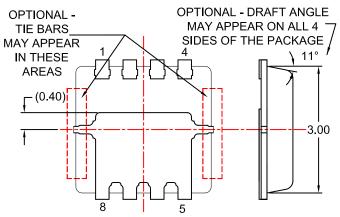
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**DATE 31 OCT 2016** 







ALL DIMENSIONS AS PER OPTION A
UNLESS SPECIFIED
BOTTOM VIEW
(OPTION C)

## NOTES:

- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC REGISTRATION MO-240.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN
- E. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. BURRS OR MOLD FLASH SHALL NOT EXCEED 0.10MM.

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DESCRIPTION:	WDFN8 3.3X3.3, 0.65P		PAGE 2 OF 2

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